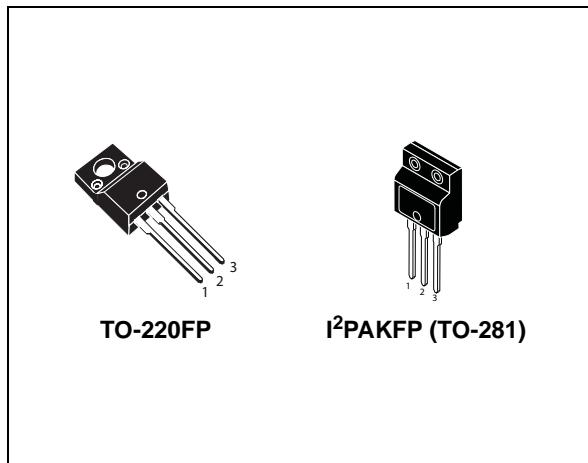


## N-channel 650 V, 0.37 Ω typ., 10 A MDmesh™ M2 Power MOSFETs in TO-220FP and I<sup>2</sup>PAKFP packages

Datasheet - production data



**Figure 1. Internal schematic diagram**

## Features

Order code	V <sub>DS</sub>	R <sub>DS(on)</sub> max	I <sub>D</sub>
STF13N65M2	650 V	0.43 Ω	10A
STFI13N65M2			

- Extremely low gate charge
- Excellent output capacitance (C<sub>oss</sub>) profile
- 100% avalanche tested
- Zener-protected

## Applications

- Switching applications

## Description

These devices are N-channel Power MOSFETs developed using MDmesh™ M2 technology. Thanks to their strip layout and improved vertical structure, the devices exhibit low on-resistance and optimized switching characteristics, rendering them suitable for the most demanding high efficiency converters.

**Table 1. Device summary**

Order code	Marking	Package	Packaging
STF13N65M2	13N65M2	TO-220FP	Tube
STFI13N65M2		I <sup>2</sup> PAKFP (TO-281)	

## Contents

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# 1 Electrical ratings

**Table 2. Absolute maximum ratings**

Symbol	Parameter	Value	Unit
$V_{GS}$	Gate-source voltage	$\pm 25$	V
$I_D$	Drain current (continuous) at $T_C = 25^\circ\text{C}$	$10^{(1)}$	A
$I_D$	Drain current (continuous) at $T_C = 100^\circ\text{C}$	$6.3^{(1)}$	A
$I_{DM}^{(2)}$	Drain current (pulsed)	$40^{(1)}$	A
$P_{TOT}$	Total dissipation at $T_C = 25^\circ\text{C}$	25	W
$V_{ISO}$	Insulation withstand voltage (RMS) from all three leads to external heat sink ( $t = 1 \text{ s}$ ; $T_C = 25^\circ\text{C}$ )	2500	V
$dv/dt^{(3)}$	Peak diode recovery voltage slope	15	V/ns
$dv/dt^{(4)}$	MOSFET dv/dt ruggedness	50	
$T_{stg}$	Storage temperature	- 55 to 150	$^\circ\text{C}$
$T_j$	Max. operating junction temperature	150	

1. Limited by maximum junction temperature..
2. Pulse width limited by safe operating area.
3.  $I_{SD} \leq 10 \text{ A}$ ,  $di/dt \leq 400 \text{ A}/\mu\text{s}$ ;  $V_{DS \text{ peak}} < V_{(BR)DSS}$ ,  $V_{DD}=400 \text{ V}$
4.  $V_{DS} \leq 520 \text{ V}$

**Table 3. Thermal data**

Symbol	Parameter	Value	Unit
$R_{thj-case}$	Thermal resistance junction-case max	5	$^\circ\text{C/W}$
$R_{thj-amb}$	Thermal resistance junction-ambient max	62.5	$^\circ\text{C/W}$

**Table 4. Avalanche characteristics**

Symbol	Parameter	Value	Unit
$I_{AR}$	Avalanche current, repetitive or not repetitive (pulse width limited by $T_{jmax}$ )	1.8	A
$E_{AS}$	Single pulse avalanche energy (starting $T_j = 25^\circ\text{C}$ , $I_D = I_{AR}$ ; $V_{DD} = 50 \text{ V}$ )	350	mJ

## 2 Electrical characteristics

( $T_C = 25^\circ\text{C}$  unless otherwise specified)

**Table 5. On /off states**

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$V_{(\text{BR})\text{DSS}}$	Drain-source breakdown voltage	$I_D = 1 \text{ mA}, V_{GS} = 0 \text{ V}$	650			V
$I_{\text{DSS}}$	Zero gate voltage drain current ( $V_{GS} = 0$ )	$V_{DS} = 650 \text{ V}$			1	$\mu\text{A}$
		$V_{DS} = 650 \text{ V}, T_C = 125^\circ\text{C}$			100	$\mu\text{A}$
$I_{GSS}$	Gate-body leakage current ( $V_{DS} = 0$ )	$V_{GS} = \pm 25 \text{ V}$			$\pm 10$	$\mu\text{A}$
$V_{GS(\text{th})}$	Gate threshold voltage	$V_{DS} = V_{GS}, I_D = 250 \mu\text{A}$	2	3	4	V
$R_{DS(\text{on})}$	Static drain-source on-resistance	$V_{GS} = 10 \text{ V}, I_D = 5 \text{ A}$		0.37	0.43	$\Omega$

**Table 6. Dynamic**

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$C_{iss}$	Input capacitance	$V_{DS} = 100 \text{ V}, f = 1 \text{ MHz}, V_{GS} = 0 \text{ V}$	-	590	-	pF
$C_{oss}$	Output capacitance		-	27.5	-	pF
$C_{rss}$	Reverse transfer capacitance		-	1.1	-	pF
$C_{oss \text{ eq.}}^{(1)}$	Equivalent output capacitance	$V_{DS} = 0 \text{ to } 520 \text{ V}, V_{GS} = 0 \text{ V}$	-	168.5	-	pF
$R_G$	Intrinsic gate resistance	$f = 1 \text{ MHz}$ open drain	-	6.5	-	$\Omega$
$Q_g$	Total gate charge	$V_{DD} = 520 \text{ V}, I_D = 10 \text{ A}, V_{GS} = 10 \text{ V}$ , (see <a href="#">Figure 15</a> )	-	17	-	nC
$Q_{gs}$	Gate-source charge		-	3.3	-	nC
$Q_{gd}$	Gate-drain charge		-	7	-	nC

1.  $C_{oss \text{ eq.}}$  is defined as a constant equivalent capacitance giving the same charging time as  $C_{oss}$  when  $V_{DS}$  increases from 0 to 80%  $V_{DSS}$

**Table 7. Switching times**

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$t_{d(\text{on})}$	Turn-on delay time	$V_{DD} = 325 \text{ V}, I_D = 5 \text{ A}, R_G = 4.7 \Omega, V_{GS} = 10 \text{ V}$ , (see <a href="#">Figure 14</a> and <a href="#">Figure 19</a> )	-	11	-	ns
$t_r$	Rise time		-	7.8	-	ns
$t_{d(\text{off})}$	Turn-off delay time		-	38	-	ns
$t_f$	Fall time		-	12	-	ns

**Table 8. Source drain diode**

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$I_{SD}$	Source-drain current		-		10	A
$I_{SDM}^{(1)}$	Source-drain current (pulsed)		-		40	A
$V_{SD}^{(2)}$	Forward on voltage	$I_{SD} = 10 \text{ A}, V_{GS} = 0 \text{ V}$	-		1.6	V
$t_{rr}$	Reverse recovery time		-	312		ns
$Q_{rr}$	Reverse recovery charge	$I_{SD} = 10 \text{ A}, di/dt = 100 \text{ A}/\mu\text{s}, V_{DD} = 60 \text{ V}$ (see <i>Figure 16</i> )	-	2.7		$\mu\text{C}$
$I_{RRM}$	Reverse recovery current		-	17.5		A
$t_{rr}$	Reverse recovery time		-	464		ns
$Q_{rr}$	Reverse recovery charge	$I_{SD} = 10 \text{ A}, di/dt = 100 \text{ A}/\mu\text{s}, V_{DD} = 60 \text{ V}, T_j = 150 \text{ }^\circ\text{C}$ , (see <i>Figure 16</i> )	-	4.1		$\mu\text{C}$
$I_{RRM}$	Reverse recovery current		-	17.5		A

1. Pulse width limited by safe operating area.
2. Pulsed: pulse duration = 300  $\mu\text{s}$ , duty cycle 1.5%

## 2.1 Electrical characteristics (curves)

Figure 2. Safe operating area

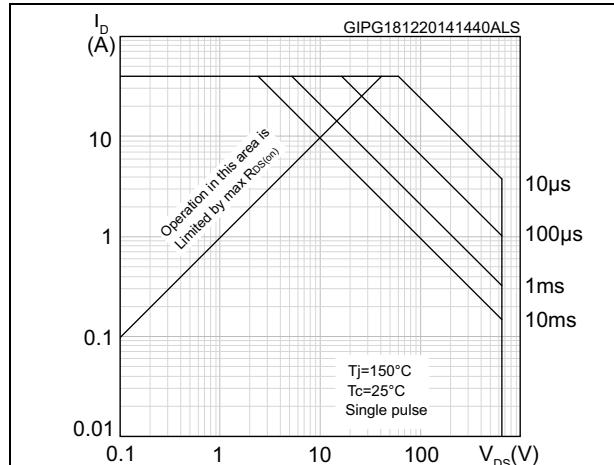


Figure 3. Thermal impedance

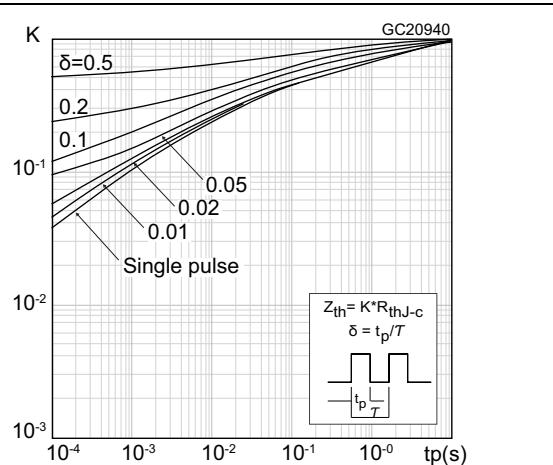


Figure 4. Output characteristics

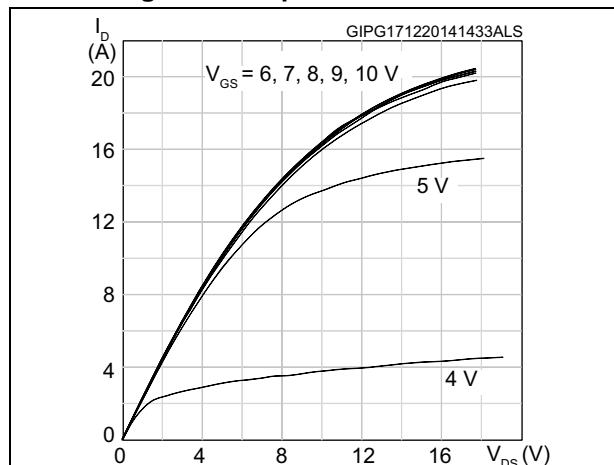


Figure 5. Transfer characteristics

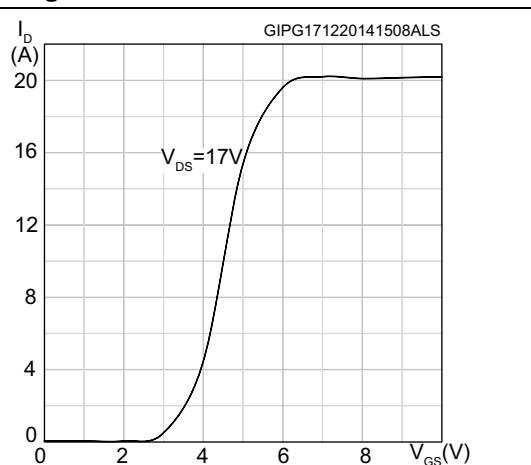
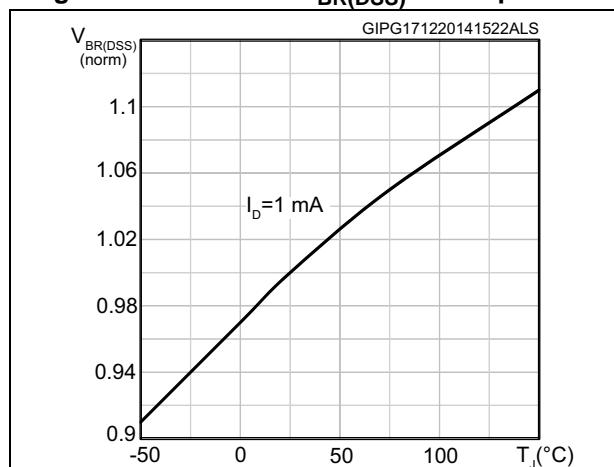
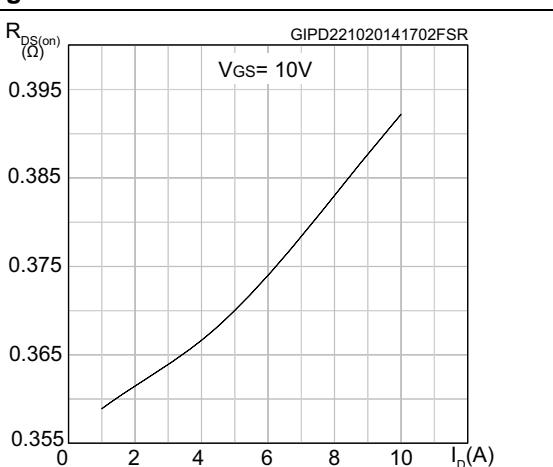
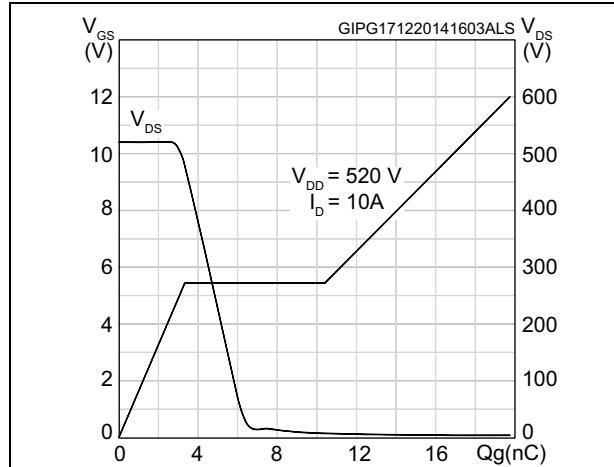
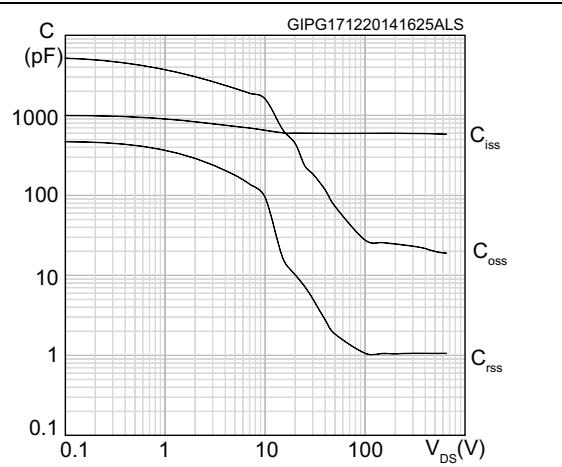
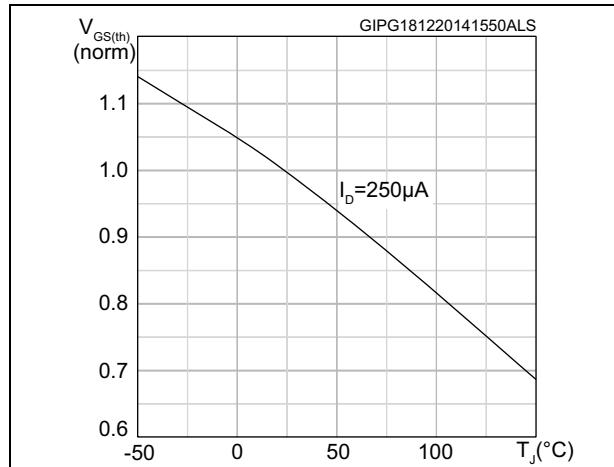
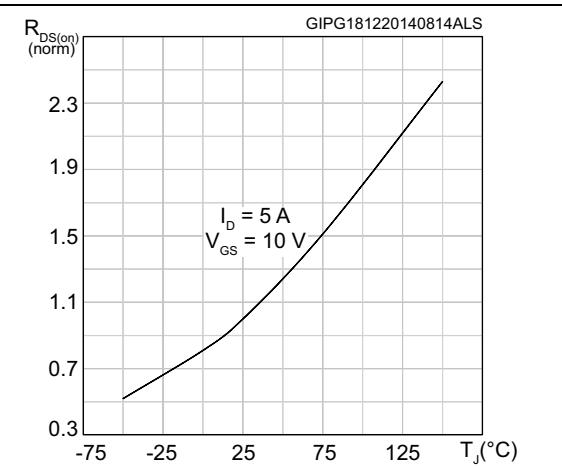
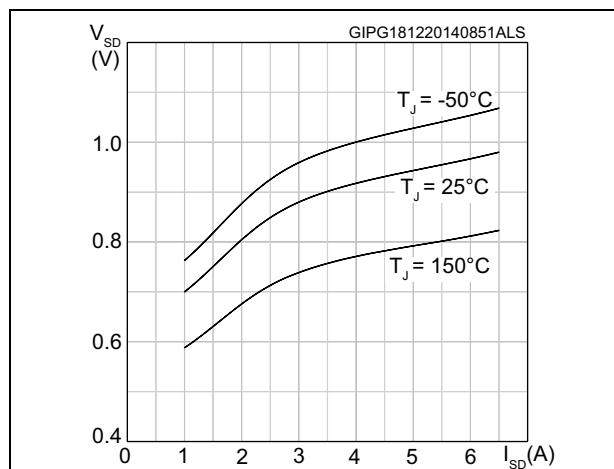
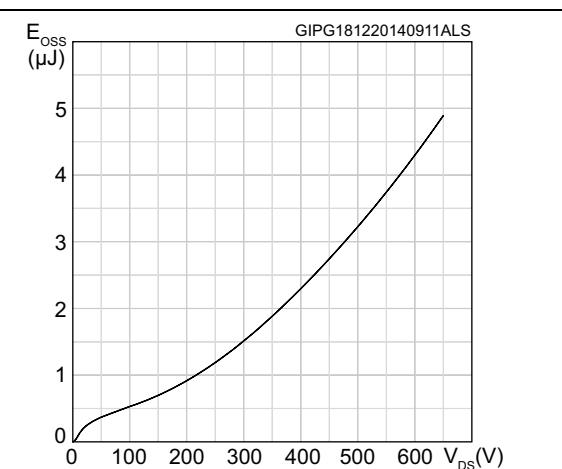
Figure 6. Normalized  $V_{BR(DSS)}$  vs temperature

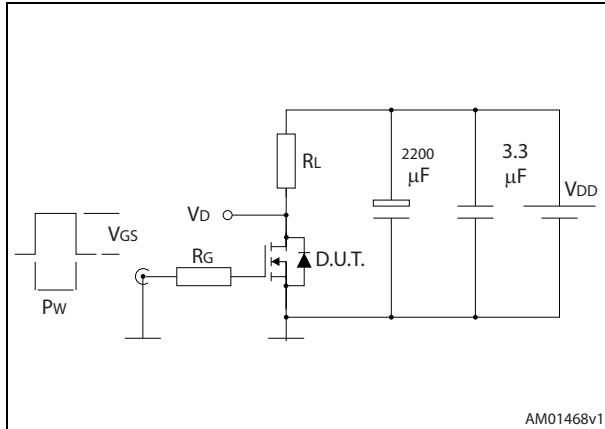
Figure 7. Static drain-source on-resistance



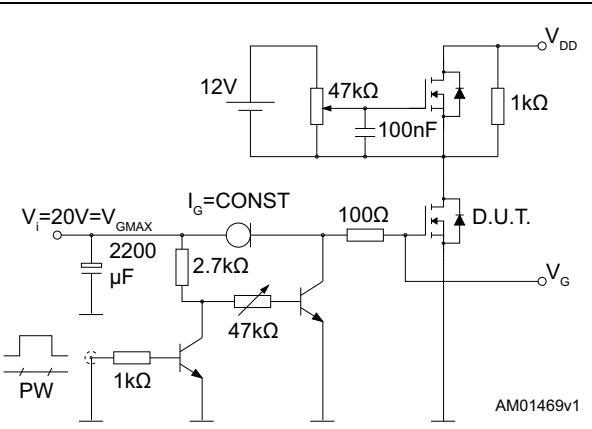
**Figure 8. Gate charge vs gate-source voltage****Figure 9. Capacitance variations****Figure 10. Normalized gate threshold voltage vs temperature****Figure 11. Normalized on-resistance vs temperature****Figure 12. Source-drain diode forward characteristics****Figure 13. Output capacitance stored energy**

### 3 Test circuits

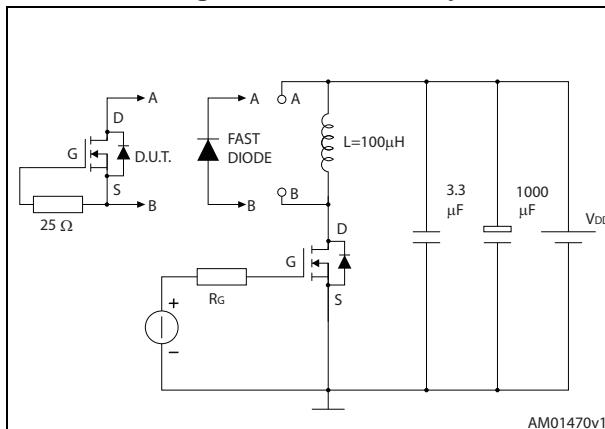
**Figure 14. Switching times test circuit for resistive load**



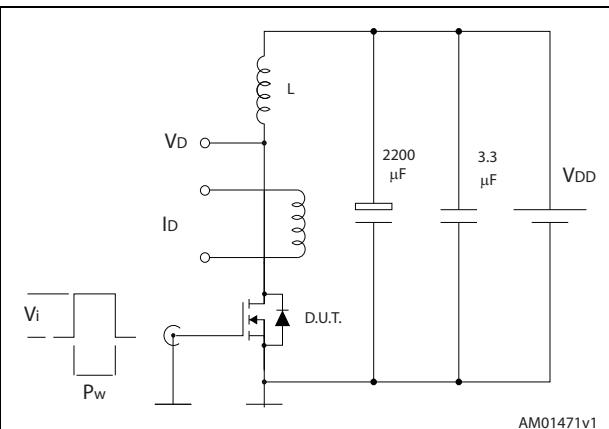
**Figure 15. Gate charge test circuit**



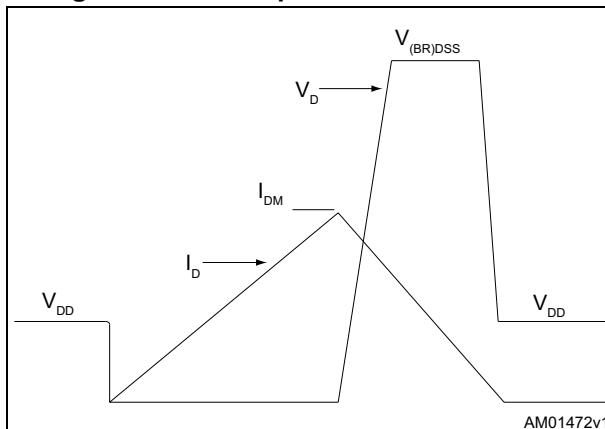
**Figure 16. Test circuit for inductive load switching and diode recovery times**



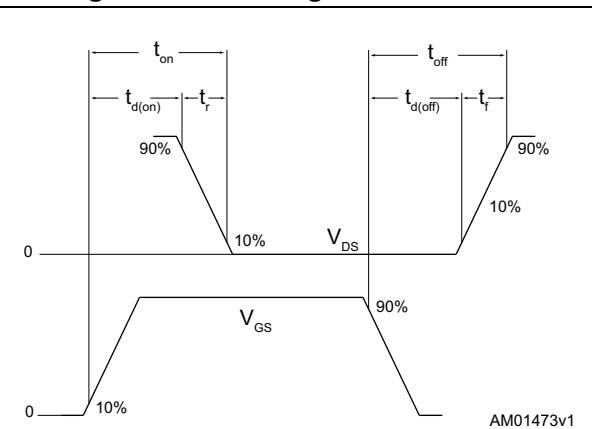
**Figure 17. Unclamped inductive load test circuit**



**Figure 18. Unclamped inductive waveform**



**Figure 19. Switching time waveform**

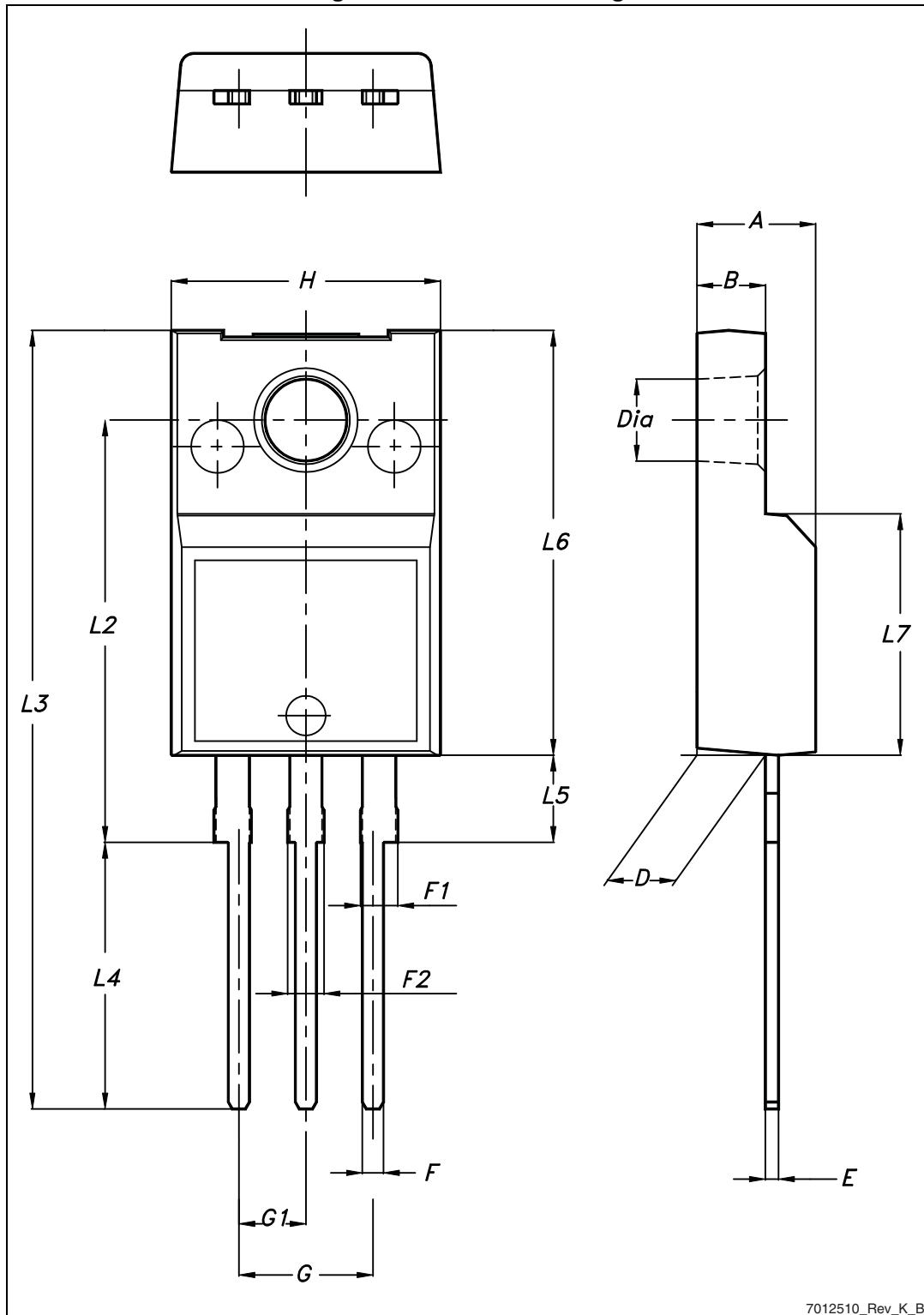


## 4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: [www.st.com](http://www.st.com).  
ECOPACK® is an ST trademark.

## 4.1 TO-220FP, STF13N65M2

Figure 20. TO-220FP drawing



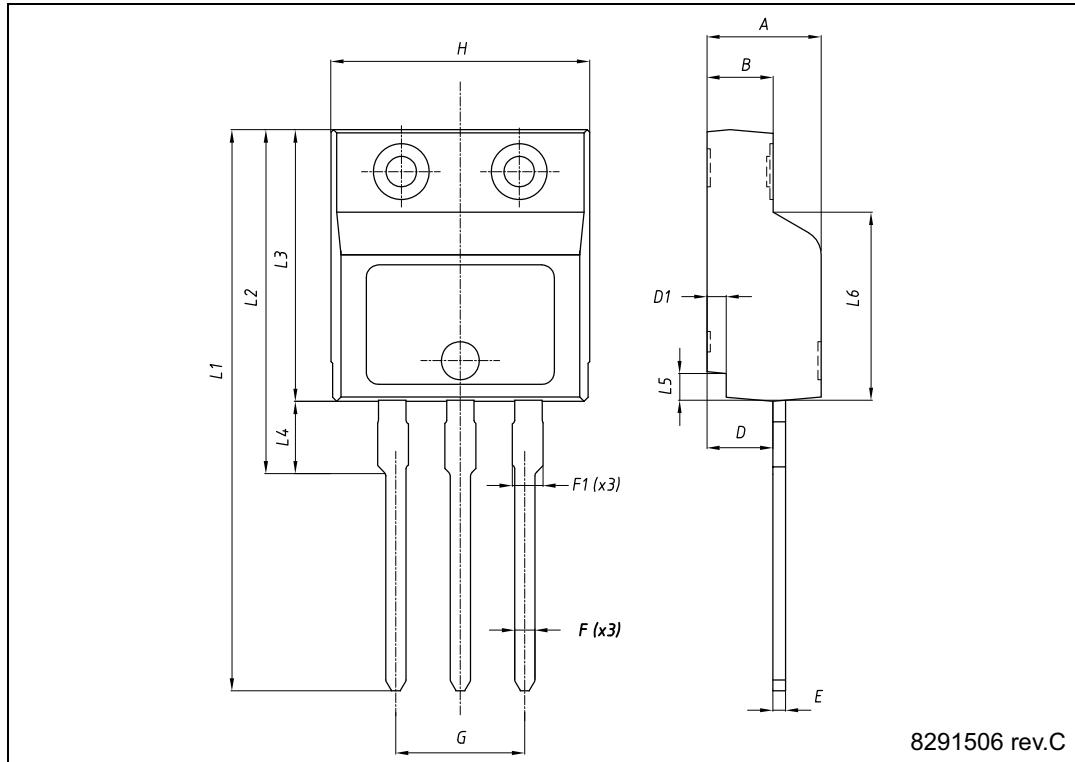
7012510\_Rev\_K\_B

**Table 9. TO-220FP mechanical data**

Dim.	mm		
	Min.	Typ.	Max.
A	4.4		4.6
B	2.5		2.7
D	2.5		2.75
E	0.45		0.7
F	0.75		1
F1	1.15		1.70
F2	1.15		1.70
G	4.95		5.2
G1	2.4		2.7
H	10		10.4
L2		16	
L3	28.6		30.6
L4	9.8		10.6
L5	2.9		3.6
L6	15.9		16.4
L7	9		9.3
Ø	3		3.2

## 4.2 I<sup>2</sup>PAKFP (TO-281), STFI13N65M2

Figure 21. I<sup>2</sup>PAKFP (TO-281) drawing



**Table 10. I<sup>2</sup>PAKFP (TO-281) mechanical data**

Dim.	mm		
	Min.	Typ.	Max.
A	4.40	-	4.60
B	2.50		2.70
D	2.50		2.75
D1	0.65		0.85
E	0.45		0.70
F	0.75		1.00
F1			1.20
G	4.95		5.20
H	10.00		10.40
L1	21.00		23.00
L2	13.20		14.10
L3	10.55		10.85
L4	2.70		3.20
L5	0.85		1.25
L6	7.50	7.60	7.70

## 5 Revision history

Table 11. Document revision history

Date	Revision	Changes
15-Oct-2014	1	Initial release
18-Dec-2014	2	Text edits throughout document Updated <a href="#">Section 1: Electrical ratings</a> Updated <a href="#">Section 2: Electrical characteristics</a> Added <a href="#">Section 2.1: Electrical characteristics (curves)</a> Updated <a href="#">Section 4.2: PPAKFP (TO-281), STFI13N65M2</a>

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